

Symbol	Count	Hole Size	Plated	Hole Type	Drill Layer Pair	Via/Pad	Pad Shape
	4	3.500mm (137.79mil)	NPTH	Round	Top Layer - Bottom Layer	Pad	Rounded
0	840	0.500mm (19.69mil)	NPTH	Round	Top Layer - Bottom Layer	Pad	Rounded
∇	870	0.300mm (11.81mil)	PTH	Round	Top Layer - Bottom Layer	Via	Rounded
	1714 Total						

	LAYER BUILD DATA						
SHT	DESCRIPTION	PLOTFILE	EXT	P/N			
1	CUTTING & DRILLING DRAWING	SMP [Panel]	GD1	-			
2	TOP SIDE LEGEND	SMP [Panel]	GTO	POS			
3	TOP SIDE SOLDER MASK	SMP [Panel]	GTS	NEG			
4	TOP SIDE	SMP [Panel]	GTL	POS			
5	BOTTOM SIDE	SMP [Panel]	GBL	POS			
6	BOTTOM SIDE SOLDER MASK	SMP [Panel]	GBS	NEG			
7	BOTTOM SIDE LEGEND	SMP [Panel]	GBO	POS			

SOLDER STENCIL DATA						
SHT	DESCRIPTION	PLOTFILE	EXT	P/N		
1	TOP SIDE SOLDER STENCIL	SMP [Panel]	GTP	POS		
2	BOTTOM SIDE SOLDER STENCIL	SMP [Panel]	GBP	POS		

	MATERIAL					
ITEM	FINAL THICKNESS	MATERIAL				
Cu	35um (ON ALL LAYERS)	COPPER CLAD				
РСВ	1.60mm	FR4 TG130				

	FINISH
ITEM	DESCRIPTION
PCB	IMMERSION GOLD
SOLDER MASK	BLUE PHOTO-IMAGEABLE
LEGEND	WHITE EPOXY

GENTICK ELECTRONICS EXPERTS IN TELEMETRY SYSTEMS					
TOLERANCES UNLESS OTHERWISE STATED					
1 = +/-0.2	1.0 = +/-0.1	1.00 = +/-0.05	'		

	UNITS							TITLE
METRIC							SN (CUT	
	SCALE							(CU1
	N/A							
		EDM	-	-	19/11/2024	01	-	DWG NUMBE
		DRAWN	CHECKED	APPROVED	DATE	DOC REV.	ECR NO.	SOURCE

SMP PCB (CUTTING & DRILLING DRAWING)

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1BER	-	PCB VER	SHEET N
	SMP [Panel] PchDoc	11.00	SHEET 1 OF























